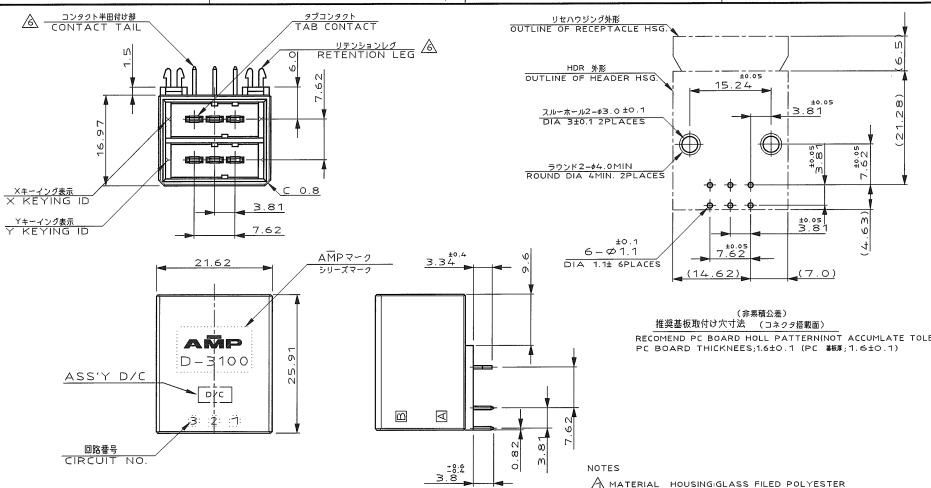


推奨基板取付け穴寸法 (コネクタ嵌合面)
(非累積公差)
RECOMEND PC BOARD HOLL PATTERN(NOT ACCUMLATE TOLERANCE)
PC BOARD THICKNEES;1.6±0.1 (PC 基板厚;1.6±0.1)

NOTES
⚠1 MATERIAL HOUSING:GLASS FILED POLYESTER
CONTACT:COPPER ALLOY
RETENTION LEG:COPPER ALLOY
⚠2 FINISH(CONTACT AREA): 0.38μm PdNi & Au PLATING OVER NICKEL
⚠3 FINISH(CONTACT AREA): 0.76μm PdNi & Au PLATING OVER NICKEL
⚠4 FINISH(CONTACT):2.0 μMIN TIN PLATED OVER NICKEL
~~⚠5 FINISH(RETENTION LEG AND CONTACT TAIL):TIN LEAD PLATED OVER NICKEL~~
⚠6 FINISH(RETENTION LEG): TIN PLATED
(CONTACT TAIL) OVER NICKEL
⚠7 FINISH(CONTACT AREA): 0.76um Au PLATING OVER NICKEL

KEYING LOCATION	KEYING NAME	FINISH	PART NO.
	XY	⚠6 ⚠4	3-178137-5
		⚠6 ⚠3	3-178137-3
		⚠6 ⚠2	3-178137-2
	YY	⚠6 ⚠4	2-178137-5
		⚠6 ⚠3	2-178137-3
		⚠6 ⚠2	2-178137-2
	XX	⚠6 ⚠4	1-178137-5
		⚠6 ⚠3	1-178137-3
		⚠6 ⚠2	1-178137-2

LTR	REVISION RECORD	DR	CHK	DATE
D1	REVISED PER ECT-26-292744	F.Z	LL	09OCT 2026
D	REVISED PER ECR-25-250788	F.Z	R.B	16JAN 2025
C1	REVISED PER ECO-11-205030	RK	HMR	30MAY17

DR.	Y.TANAKA	6-JUL-'92	
CHK.	S.MANABE	6-JUL-'92	
APP.	S.MANABE	6-JUL-'92	

WIRE RANGE mm² (AWG -) — INSULATION DIA mm (TYP.) —
MATERIAL SEE NOTE 注記参照
FINISH SEE NOTE 注記参照

NAME: DYNAMIC D-3100 3.81 X 7.62 PITCH(H) 6POS. HDR CONN. ASS'Y (KEY;XX,YY,XY)
SIZE A3 | LOC J | NUMBER C-178137
一般公差 (GENERAL TOLERANCE)
.X±0.3 .XX±0.2 .XXX±0.05 ANGLE ±3°
SCALE 2-1 | REV. D1 | SHEET 1 OF 1

TE Connectivity

PRINT DIST | DIMENSIONS IN MILLIMETERS. DO NOT SCALE PRINT | METRIC | 3rd ANGLE PROJECTION | NUMBER 178137

(CUSTOMER DRAWING) 顧客用図面